

60V N-Channel self protected enhancement mode IntelliFET™ MOSFET with status indication

Summary

 $\begin{array}{lll} \mbox{Continuous drain source voltage} & \mbox{V}_{DS} = 60 \mbox{V} \\ \mbox{On-state resistance} & 500 \mbox{m}\Omega \\ \mbox{Nominal load current (V}_{IN} = 5 \mbox{V}) & 1.4 \mbox{A} \\ \mbox{Clamping energy} & 550 \mbox{mJ} \\ \end{array}$

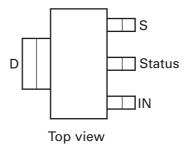


Description

Self protected low side MOSFET. Monolithic over temperature, over current, over voltage (active clamp) and ESD protected logic level functionality. Intended as a general purpose switch, with status indication.

Features

- Status pin (analog status indication)
- · Short circuit protection with auto restart
- Over voltage protection (active clamp)
- Thermal shutdown with auto restart
- Over-current protection
- Input protection (ESD)
- Load dump protection (actively protects load)
- · Logic level input
- · High continuous current rating

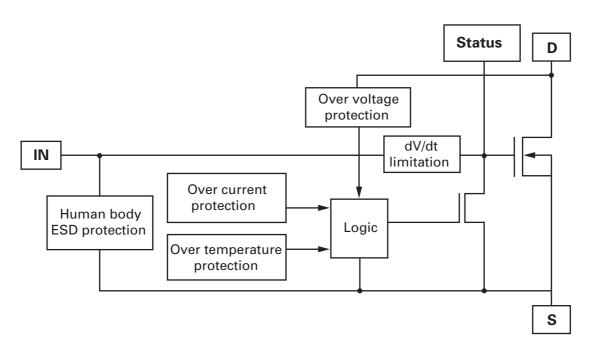


Note: The tab is connected to the drain pin and must be electrically isolated from the source pin. Connection of significant copper to the tab is recommended for best thermal performance.

Ordering information

Device	Part mark	Reel size (inches)	Tape width (mm)	Quantity per reel
ZXMS6002GTA	ZXMS6002	7	12 embossed	1000

Functional block diagram



Applications and information

- · Especially suited for loads with a high in-rush current such as lamps and motors
- · All types of resistive, inductive and capacitive loads in switching applications
- μC compatible power switch for 12V and 24V DC applications
- Automotive rated
- Replaces electromechanical relays and discrete circuits
- Linear mode capability the current-limiting protection circuitry is designed to de-activate at low V_{DS}, in order not to compromise the load current during normal operation. The design max. DC operating current is therefore determined by the thermal capability of the package/ board combination, rather than by the protection circuitry

Note: This does not compromise the product's ability to self-protect during short-circuit load conditions.

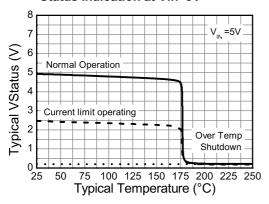
Status pin voltage reflects the gate drive being applied internally to the power MOSFET.
 With V_{IN} = 5V:

Status voltage ~ 5V indicates normal operation.

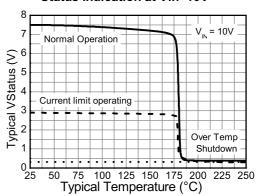
Status voltage ~ (2-3)V indicates that the device is in current-limiting mode.

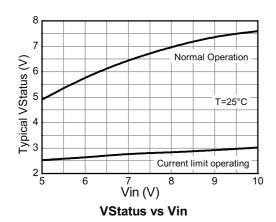
Status voltage < 1V indicates that the device is in thermal shutdown.

Current Limiting and Over Temp Shutdown Status Indication at Vin=5V



Current Limiting and Over Temp Shutdown Status Indication at Vin=10V





Absolute maximum ratings

Parameter	Symbol	Limit	Unit
Continuous drain-source voltage	V _{DS}	60	V
Drain-source voltage for short circuit protection V _{IN} =5V	V _{DS(SC)}	36	V
Drain-source voltage for short circuit protection V _{IN} =10V	V _{DS(SC)}	20	V
Continuous input voltage	V _{IN}	-0.2 +10	V
Peak input voltage	V _{IN}	-0.2 +20	V
Operating temperature range	T _j ,	-40 to +150	°C
Storage temperature range	T _{stg}	-55 to +150	°C
Power dissipation @ T _{amb} =25°C ^(a)	P_{D}	2.5	W
Continuous drain current @ V _{IN} =10V; T _{amb} =25°C ^(a)	I _D	1.6	Α
Continuous drain current @ V _{IN} =5V; T _{amb} =25°C ^(a)	I _D	1.4	Α
Continuous source current (body diode)(a)	I _S	3	Α
Pulsed source current (body diode) ^(b)	I _S	4.7	А
Unclamped single pulse inductive energy	E _{AS}	550	mJ
Load dump protection	$V_{LoadDump}$	80	V
Electrostatic discharge (human body model)	V _{ESD}	4000	V
DIN humidity category, DIN 40 040		Е	
IEC climatic category, DIN IEC 68-1		40/150/56	

Thermal resistance

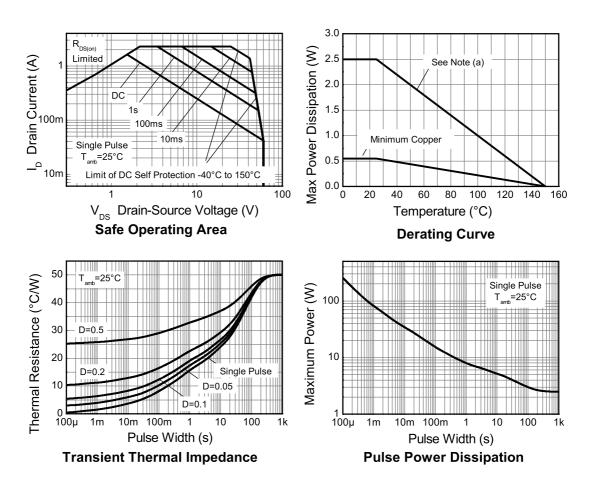
Parameter	Symbol	Limit	Unit
Junction to ambient ^(a)	R_{\ThetaJA}	50	°C/W
Junction to ambient ^(b)	$R_{\Theta JA}$	28	°C/W

NOTES:

⁽a) For a device surface mounted on 50mm x 50mm x 1.6mm FR4 board with a high coverage of single sided 2oz weight copper.

⁽b) For a device surface mounted on FR4 board as (a) and measured at t<=10s.

Characteristics



Electrical characteristics (at $T_{amb} = 25$ °C unless otherwise stated)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions	
Static characteristics							
Drain-source clamp voltage	V _{DS(AZ)}	60	70	75	V	I _D =10mA	
Off state drain current	I _{DSS}		0.1	3	μΑ	V _{DS} =12V, V _{IN} =0V	
Off state drain current	I _{DSS}		3	15	μΑ	V _{DS} =32V, V _{IN} =0V	
Input threshold voltage (*)	V _{IN(th)}	1	2.1		V	$V_{DS}=V_{GS}$, $I_{D}=1mA$	
Input current	I _{IN}		0.7	1.2	mA	V _{IN} =+5V	
Input current	I _{IN}		1.5	2.7	mA	V _{IN} =+7V	
Input current	I _{IN}		4	7	mA	V _{IN} =+10V	
Static drain-source on-state resistance	R _{DS(on)}		520	675	mΩ	V _{IN} =5V, I _D =0.7A	
Static drain-source on-state resistance	R _{DS(on)}		385	500	mΩ	V _{IN} =10V, I _D =0.7A	
Current limit (†)	I _{D(LIM)}	0.7	1.0	1.5	Α	V _{IN} =5V, V _{DS} >5V	
Current limit ^(†)	I _{D(LIM)}	1.0	1.8	2.3	Α	V _{IN} =10V, V _{DS} >5V	
Dynamic characteristics							
Turn-off time (V _{IN} to 90% I _D)	t _{off}		13	20	μS	R _L =22Ω, V _{IN} =10V to 0V, V _{DD} =12V	
Slew rate on (70 to 50% V _{DD})	-dV _{DS} /dt _{on}		8	20	V/μs	R _L =22Ω, V _{IN} =0 to 10V, V _{DD} =12V	
Slew rate off (50 to 70% V _{DD})	DV _{DS} /dt _{on}		3.2	10	V/μs	R _L =22Ω, V _{IN} =10V to 0V, V _{DD} =12V	
Protection functions (‡)							
Required input voltage for over temperature protection	V _{PROT}	4.5			V		
Thermal overload trip temperature	T _{JT}	150	175		°C		
Thermal hysteresis			1		°C		
Unclamped single pulse inductive energy T _j =25°C	E _{AS}	550			mJ	I _{D(ISO})=0.7A, V _{DD} =32V	
Unclamped single pulse inductive energy T _j =150°C	E _{AS}	200			mJ	I _{D(ISO})=0.7A, V _{DD} =32V	

Electrical characteristics (at T_{amb} = 25°C unless otherwise stated)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions
Status flag						
Normal operation	V _{STATUS}		4.95		V	V _{IN} = 5V
Current limit operating	V _{STATUS}		2.5		V	V _{IN} = 5V
Thermal shutdown activated	V _{STATUS}		0.2	1	V	V _{IN} = 5V
Normal operation	V _{STATUS}		8.0		V	V _{IN} = 10V
Current limit operation	V _{STATUS}		3.0		V	V _{IN} = 10V
Thermal shutdown activated	V _{STATUS}		0.35	1	V	V _{IN} = 10V
Inverse diode						
Source drain voltage	V_{SD}			1	V	V _{IN} =0V, -I _D =1.4A,

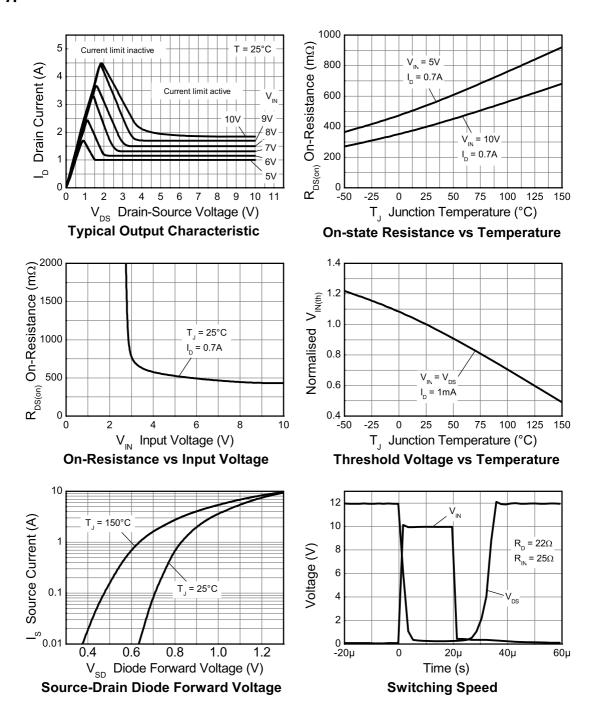
NOTES:

^(*) Protection features may operate outside spec for V_{IN} <4.5V.

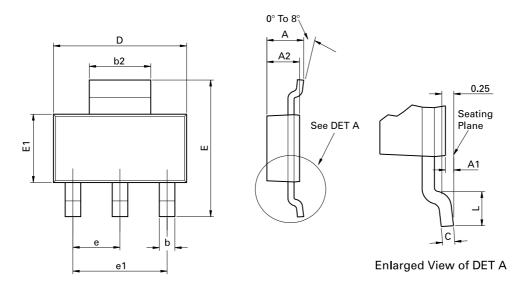
^(†) The drain current is limited to a reduced value when Vds exceeds a safe level

^(‡) Integrated protection functions are designed to prevent IC destruction under fault conditions described in the datasheet. Fault conditions are considered as "outside" normal operating range. Protection functions are not designed for continuous, repetitive operation.

Typical characteristics



Package outline - SOT223



Conforms to JEDEC TO-261 AA Issue B

DIM	Millin	neters	Inc	hes	DIM	Millimeters		Inches	
	Min	Max	Min	Max		Min	Max	Min	Max
Α	-	1.80	-	0.071	е	2.30	BSC	0.090	5 BSC
A1	0.02	0.10	0.0008	0.004	e1	4.60	BSC	0.181	BSC
b	0.66	0.84	0.026	0.033	E	6.70	7.30	0.264	0.287
b2	2.90	3.10	0.114	0.122	E1	3.30	3.70	0.130	0.146
С	0.23	0.33	0.009	0.013	L	0.90	-	0.355	-
D	6.30	6.70	0.248	0.264	-	-	-	-	-

Note: Controlling dimensions are in millimeters. Approximate dimensions are provided in inches

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Zetex sales offices

Europe	Americas	Asia Pacific	Corporate Headquarters
Zetex GmbH Kustermann-park Balanstraße 59 D-81541 München Germanv	Zetex Inc 700 Veterans Memorial Highway Hauppauge, NY 11788 USA	Zetex (Asia Ltd) 3701-04 Metroplaza Tower 1 Hing Fong Road, Kwai Fong Hong Kong	Zetex Semiconductors plc Zetex Technology Park, Chadderton Oldham, OL9 9LL United Kingdom
Telefon: (49) 89 45 49 49 0 Fax: (49) 89 45 49 49 49 europe.sales@zetex.com	Telephone: (1) 631 360 2222 Fax: (1) 631 360 8222 usa.sales@zetex.com	Telephone: (852) 26100 611 Fax: (852) 24250 494 asia.sales@zetex.com	Telephone: (44) 161 622 4444 Fax: (44) 161 622 4446 hq@zetex.com

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Офис по работе с юридическими лицами:

105318, г. Москва, ул. Щербаковская д. 3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: info@moschip.ru

Skype отдела продаж:

moschip.ru moschip.ru_6 moschip.ru_4 moschip.ru_9